

A Compact 300-GHz Receiver for Wireless Communications of Tens of Gigabits per Second

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- Background
- Issues and developed technologies:
 - Devices (InP HEMTs)
 - ICs (low-noise amplifier, detector, IF amplifier)
 - Packaging
- Demonstration
- Summary

THz Wave

- Not allocated above 275 GHz
- 10-100 GHz bandwidth (BW) usable
- 100 Gb/s+ possible with simple modem
- Large atmospheric attenuation

THz wave (>100 GHz)

μ wave

mm wave

~ Gb/s

~10 Gb/s

10 – ~100 Gb/s+

LTE, WiFi, etc

FWA, TV, etc

11ad

E-band

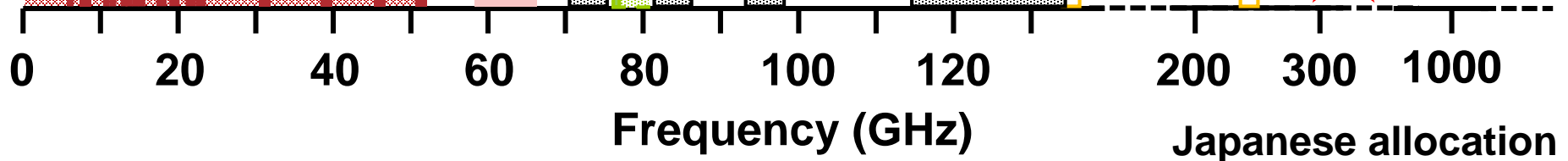
Automotive

W-band

Amateur

Target

TV relay



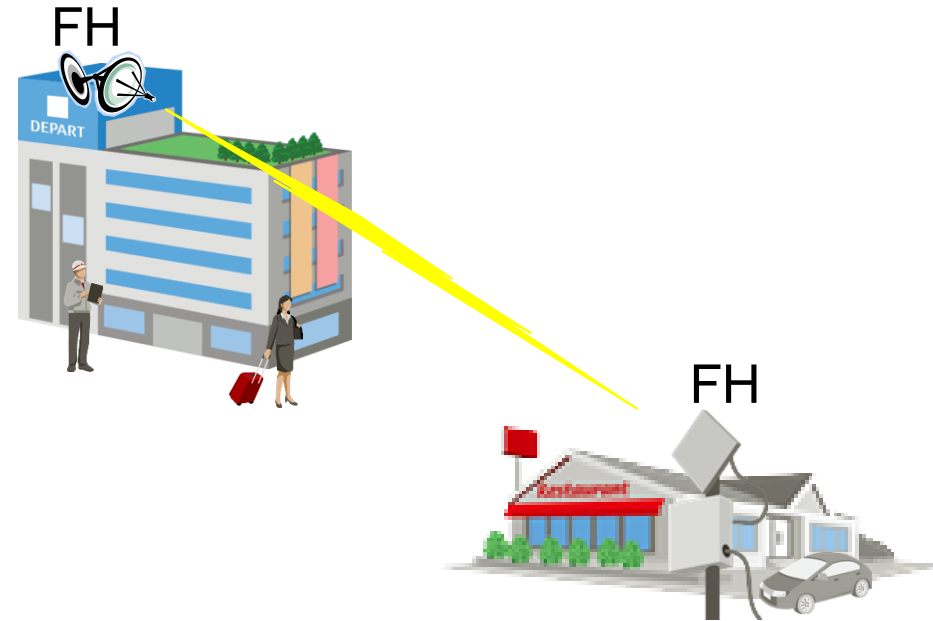
■ Short-range service

- Data downloader
- Data exchanger
- Data center



Data downloader

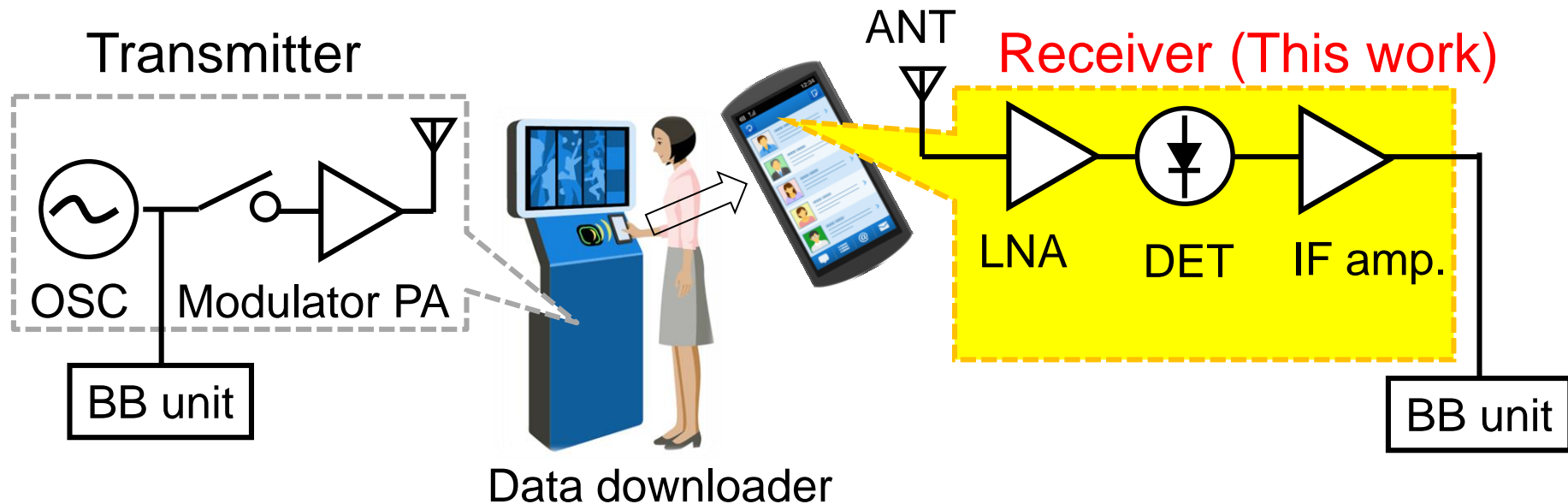
■ Fixed wireless service



Front haul (FH) for cellular

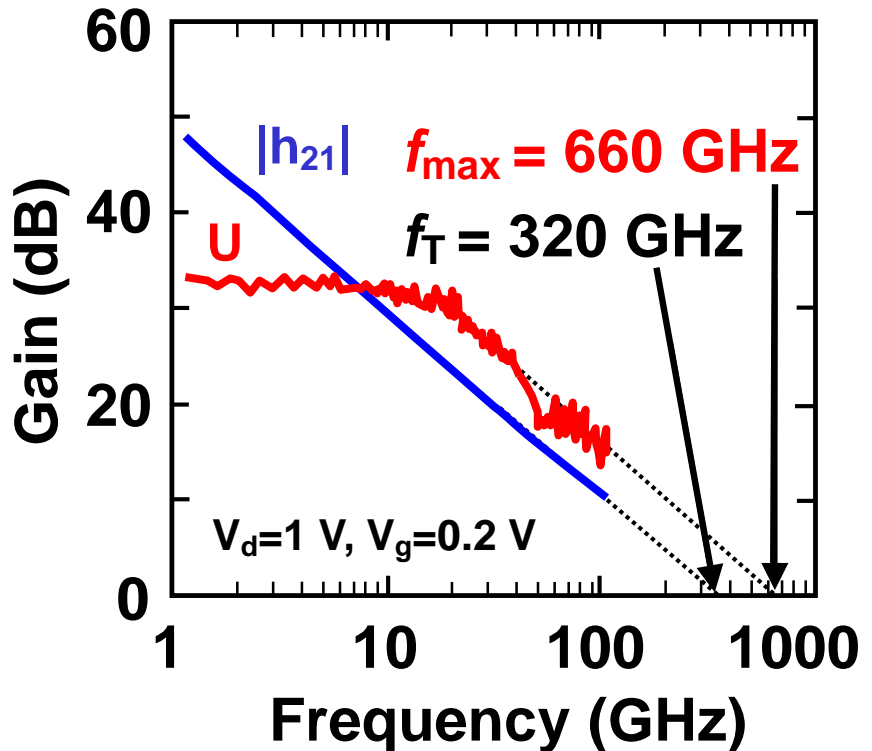
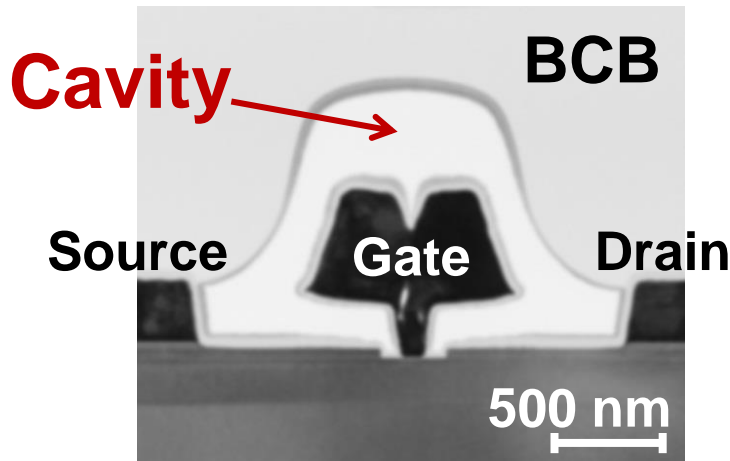
■ Compact module with small antenna

- High- f_{\max} device
- Low-noise amplifier (LNA)
- Wide-band detector (DET)
- Low-loss compact packaging



■ 75-nm InP HEMT

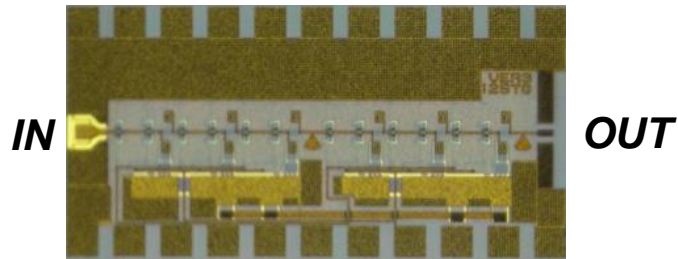
- Cavity structure
- f_T / f_{max} : 320 GHz / 660 GHz
- NF_{min} : 0.71 dB @94 GHz, 300K



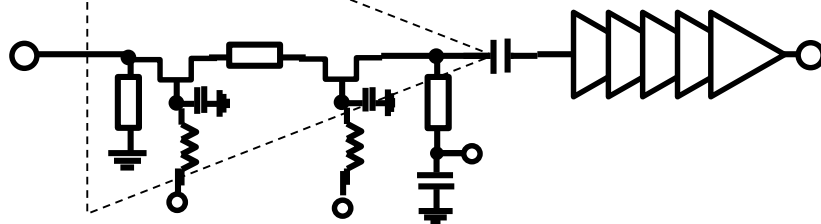
T. Takahashi *et al.*, IEEE ED 2012

InP-HEMT Low-noise Amplifier (LNA)

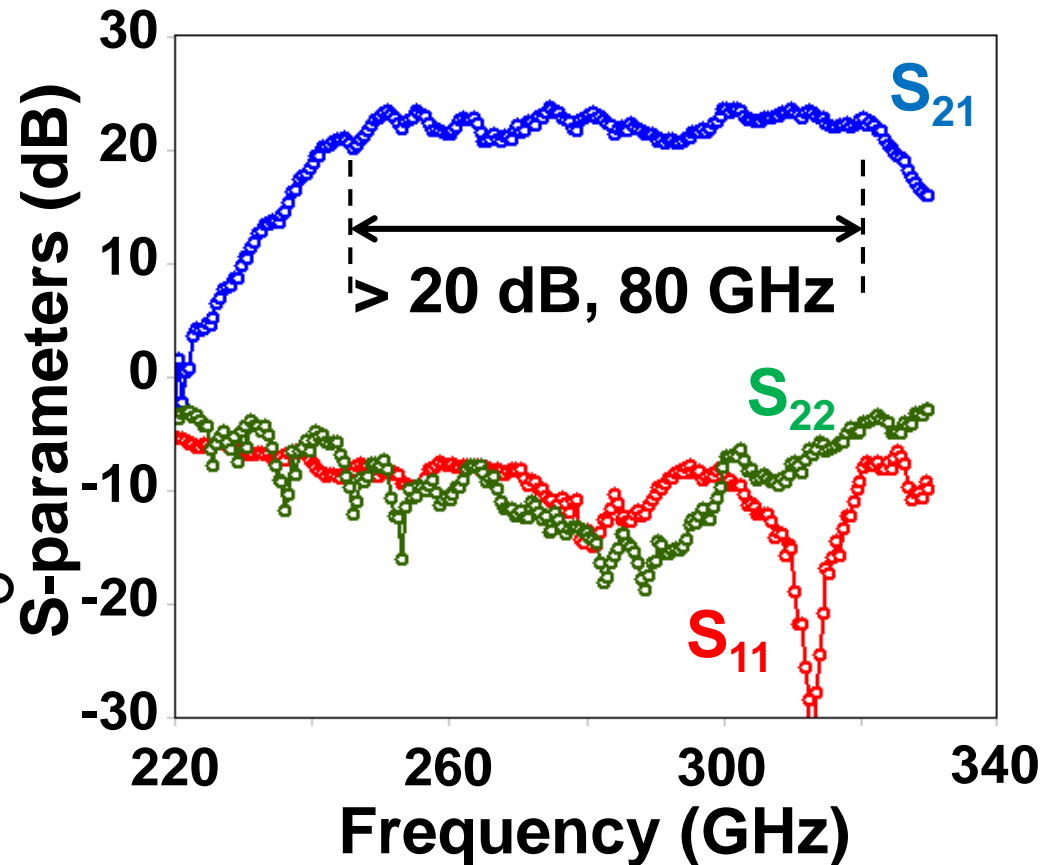
- Common-gate architecture for high gain and wide BW
- NF: 9.8 dB @300 GHz



1.8 × 0.9 mm

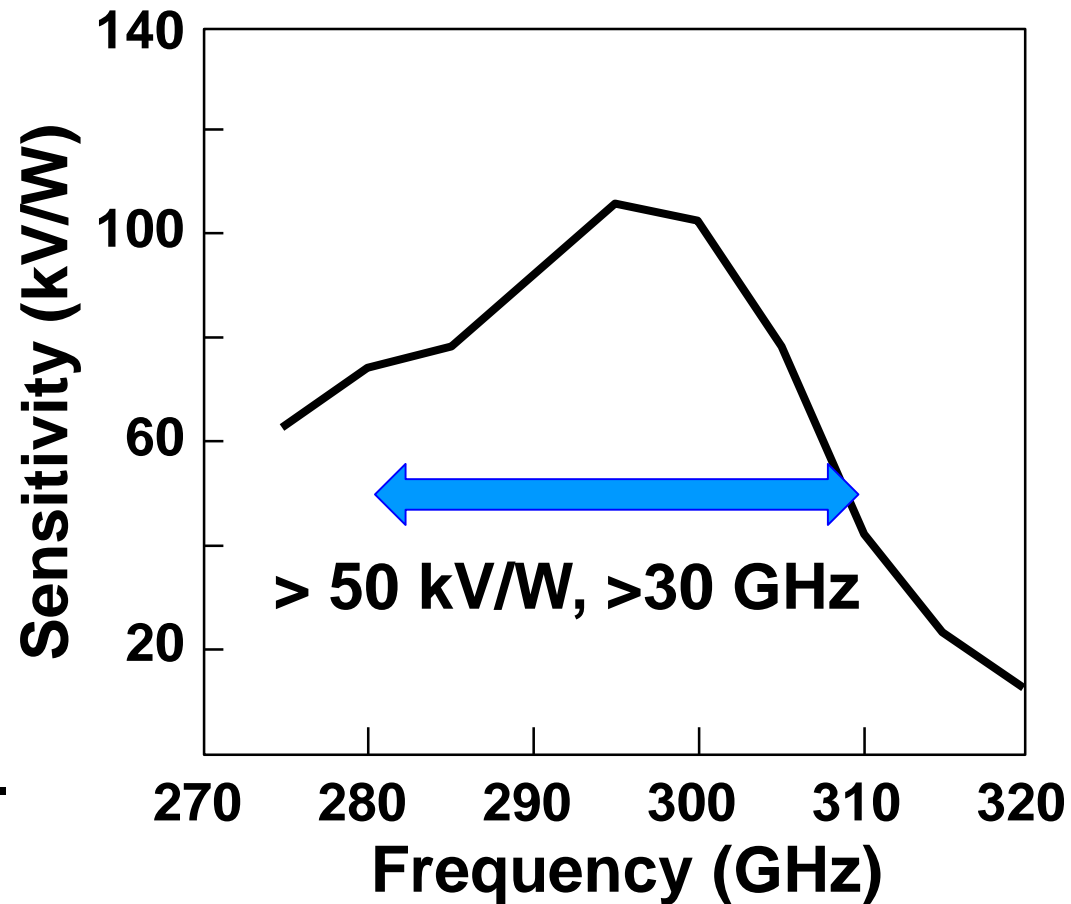
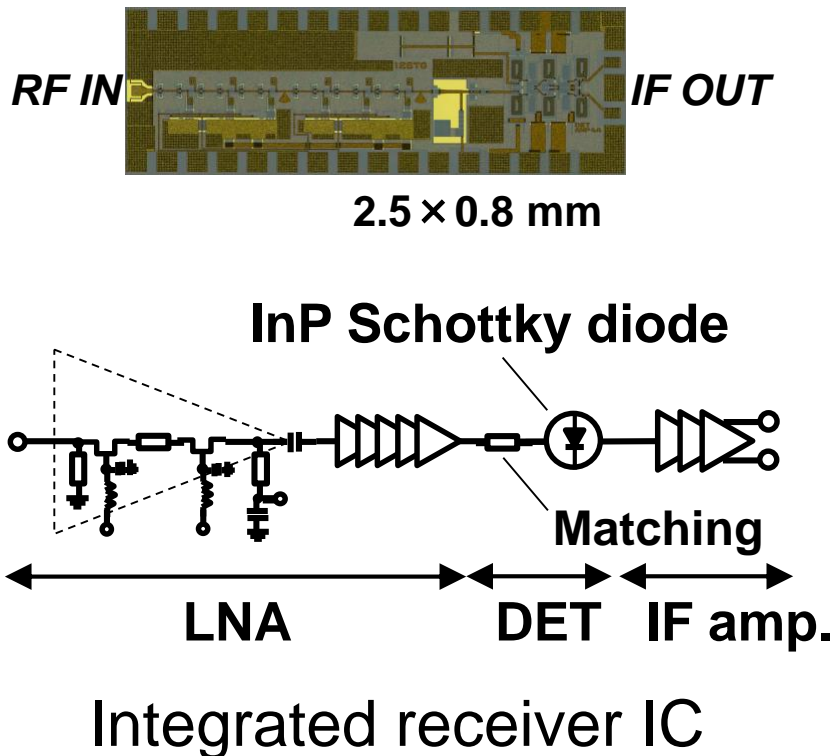


6-stage common-gate LNA



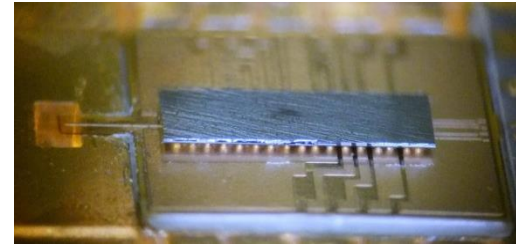
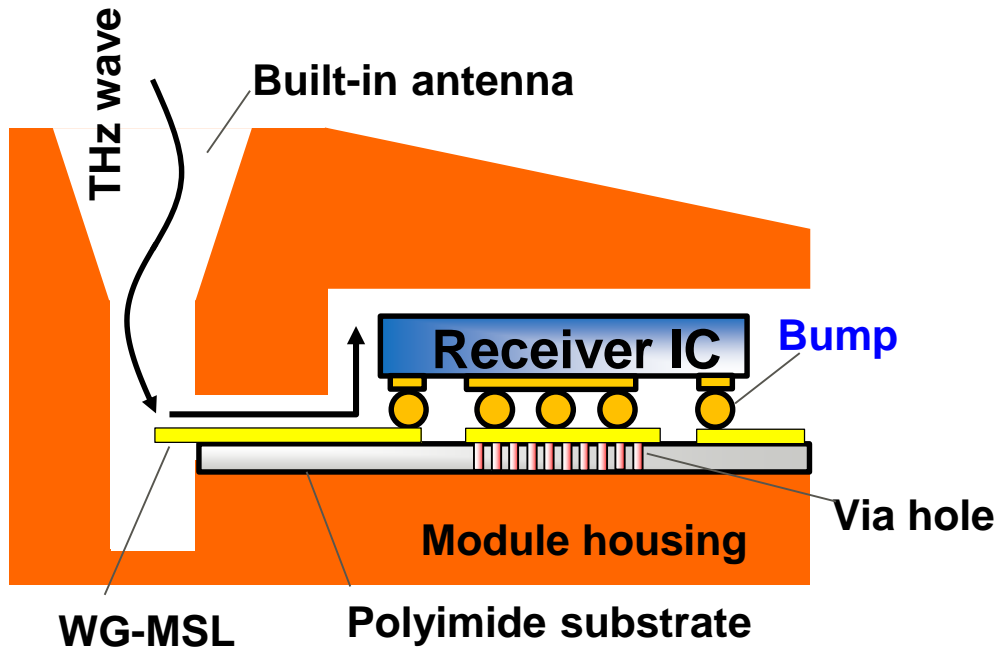
Wide-band Detector

- InP HEMT Schottky diode
- Wide-band differential IF amplifier
- All Integrated on 1 chip
- P_{diss} : 115 mW

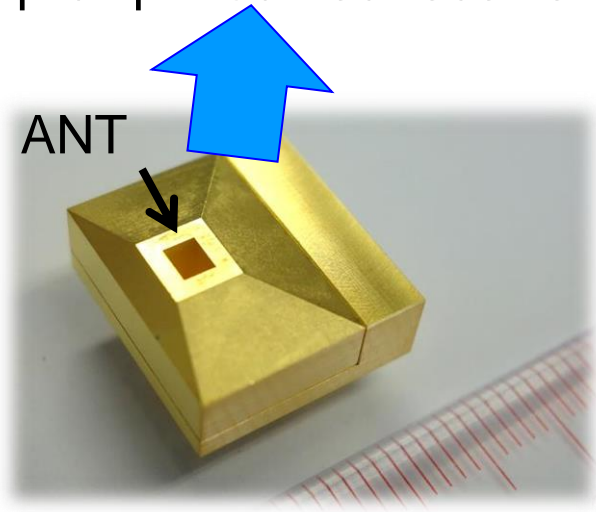


Low-loss Compact Packaging

- Expanded flip-chip mounting to THz-band for the first time
 - Employing low-loss polyimide substrate
- Compact built-in horn antenna: 16 dBi
- Cubic capacity: 0.75 cm^3



Flip-chip mounted receiver IC



Receiver module

Y. Kawano *et al.*, EuMC 2015

Downloader Demo

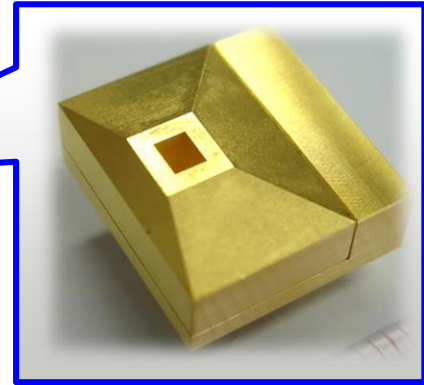
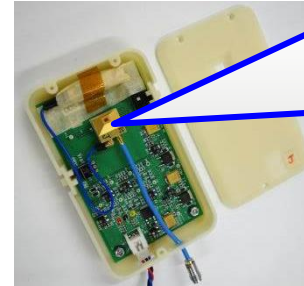
- Collaboration with NTT, NICT, and FUJITSU
- Physical rate: 20 Gb/s, effective rate: 16 Gb/s



Downloader server



Hand-held receiver



Transmitter



Downloading scene

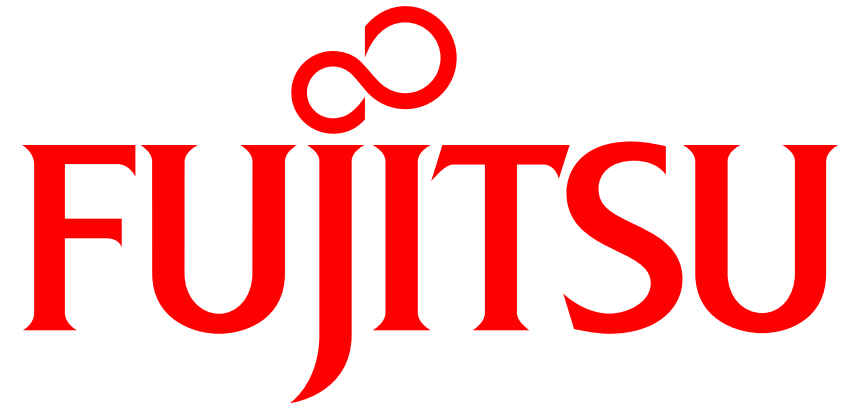
Compact THz receiver for 20-Gb/s data transmission

- 75-nm InP HEMT f_{\max} : 660 GHz
- 1-chip receiver IC
- Low-loss flip-chip mounting technique
- Cubic volume: 0.75 cm³

Instantaneous downloader demo

- 300 GHz, 20 Gb/s
- Only 2 sec. for 1-DVD data (4GB)

This work was jointly established by NTT, NICT, and FUJITSU, and was supported in part by the research and development of the Ministry of Internal Affairs and Communication, Japan



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